

# PSMN1R0-100ASE

N-channel, 100 V, 1.04 mOhm, MOSFET with enhanced SOA in CCPAK1212 package

7 February 2024

Objective data sheet

### 1. General description

N-channel enhancement mode MOSFET in a CCPAK1212 package qualified to 175 °C. Part of Nexperia's Application Specific MOSFETs (ASFETs) for Hotswap and Soft Start. The PSMN1R0-100ASE delivers very low R<sub>DSon</sub> and enhanced safe operating area performance in a high-reliability copper-clip package (CCPAK1212).

PSMN1R0-100ASE complements the latest "hot-swap" controllers - robust enough to withstand substantial inrush currents during turn-on, low  $R_{DSon}$  to minimize I²R losses and deliver optimum efficiency when turned fully ON.

#### 2. Features and benefits

- · Fully optimized Safe Opertating Area (SOA) for superior linear mode operation
- Low R<sub>DSon</sub> for low I<sup>2</sup>R conduction losses
- · CCPAK1212 package for applications that demand the highest performance and reliability

### 3. Applications

- · Hot swap
- · Load switch
- Soft start
- E-fuse
- Telecommunication systems based on a 48 V backplane/supply rail

### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	25 °C ≤ T <sub>j</sub> ≤ 175 °C		-	-	100	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 25 °C	[1]	-	-	400	Α
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; <u>Fig. 1</u>		-	-	1.07	kW
Static chara	cteristics				'		
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 25 \text{ A}; T_j = 25 ^{\circ}\text{C}$		-	0.82	1.04	mΩ
Dynamic ch	aracteristics					'	
$Q_{GD}$	gate-drain charge	I <sub>D</sub> = 25 A; V <sub>DS</sub> = 50 V; V <sub>GS</sub> = 10 V; T <sub>j</sub> = 25 °C; <u>Fig. 2</u>		-	49	-	nC
Source-drai	n diode						
Q <sub>r</sub>	recovered charge	$I_S$ = 25 A; $dI_S/dt$ = -100 A/ $\mu$ s; $V_{GS}$ = 0 V; $V_{DS}$ = 50 V; $T_j$ = 25 °C; Fig. 3	[2]	-	122	-	nC

<sup>[1]</sup> Max current will be demonstrated through application tests. Practically the current will be limited by PCB, thermal design and operating temperature.



<sup>[2]</sup> includes capacitive recovery

## 5. Pinning information

**Table 2. Pinning information** 

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		
2	S	source		
3	S	source		
4	S	source	12 11 10 9 8 7	
5	S	source	<u> </u>	
6	S	source		D
7	D	drain		
8	D	drain		G T T
9	D	drain		mbb076 S
10	D	drain	1 2 3 4 5 6 CCPAK1212 (SOT8000A)	
11	D	drain	301 AR 1212 (3010000A)	
12	D	drain		
mb	D	mounting base; connected to drain		

## 6. Ordering information

**Table 3. Ordering information** 

Type number	Package					
	Name	Description	Version			
PSMN1R0-100ASE	CCPAK1212	Plastic, surface mounted copper clip package (CCPAK1212); 13 terminals; 2.0 mm pitch, 12 mm x 12 mm x 2.5 mm body	SOT8000A			

# 7. Limiting values

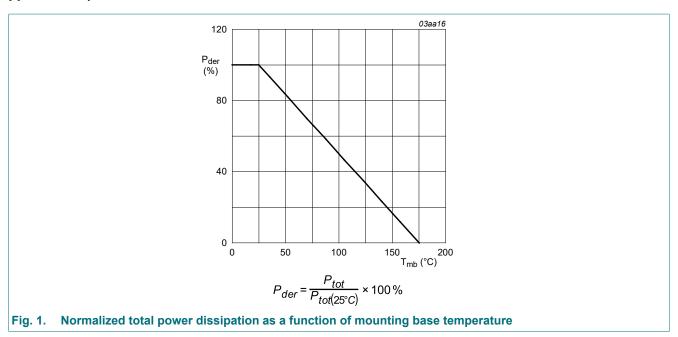
#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). T<sub>i</sub> = 25 °C unless otherwise stated.

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	25 °C ≤ T <sub>j</sub> ≤ 175 °C		-	100	V
V <sub>GS</sub>	gate-source voltage			-20	20	V
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; <u>Fig. 1</u>		-	1.07	kW
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 25 °C	[1]	-	400	А
		V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 100 °C		-	282	А
I <sub>DM</sub>	peak drain current	pulsed; $t_p \le 10 \mu s$ ; $T_{mb} = 25 °C$		-	1600	А
T <sub>stg</sub>	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
Source-drain d	iode					
Is	source current	T <sub>mb</sub> = 25 °C		-	400	А
I <sub>SM</sub>	peak source current	pulsed; $t_p \le 10 \mu s$ ; $T_{mb} = 25  ^{\circ}C$		-	1600	Α

Symbol	Parameter	Conditions		Min	Max	Unit
Avalanche ruggedness						
E <sub>DS(AL)S</sub>		$I_D$ = 116 A; $V_{sup} \le 100$ V; $R_{GS}$ = 50 Ω; $V_{GS}$ = 10 V; $T_{j(init)}$ = 25 °C; unclamped	[2]	-	1561	mJ

- [1] Max current will be demonstrated through application tests. Practically the current will be limited by PCB, thermal design and operating temperature.
- [2] Protected by 100% test



## 8. Thermal characteristics

**Table 5. Thermal characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-mb)</sub>	thermal resistance from junction to mounting base		-	[tbd]	0.14	K/W

### 9. Characteristics

**Table 6. Characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	cteristics					
V <sub>(BR)DSS</sub>	drain-source	I <sub>D</sub> = 250 μA; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	100	-	-	V
	breakdown voltage	I <sub>D</sub> = 250 μA; V <sub>GS</sub> = 0 V; T <sub>j</sub> = -55 °C	90	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C}$	2	2.6	3.6	V
		I <sub>D</sub> = 1 mA; V <sub>DS</sub> =V <sub>GS</sub> ; T <sub>j</sub> = 175 °C	-	1.6	-	V
		I <sub>D</sub> = 1 mA; V <sub>DS</sub> =V <sub>GS</sub> ; T <sub>j</sub> = -55 °C	-	3	-	V
$\Delta V_{GS(th)}/\Delta T$	gate-source threshold voltage variation with temperature	25 °C ≤ T <sub>j</sub> ≤ 150 °C	-	[tbd]	-	mV/K
I <sub>DSS</sub>	drain leakage current	V <sub>DS</sub> = 100 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	[tbd]	5	μA
		V <sub>DS</sub> = 100 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 125 °C	-	[tbd]	[tbd]	μA

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>GSS</sub>	gate leakage current	V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	2	100	nA
			-	2	100	nA
R <sub>DSon</sub>	drain-source on-state	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 25 °C	-	0.82	1.04	mΩ
Doon	resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 100 °C	-	[tbd]	[tbd]	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 175 °C	-	[tbd]	[tbd]	mΩ
R <sub>G</sub>	gate resistance	f = 1 MHz; T <sub>j</sub> = 25 °C	[tbd]	2.5	[tbd]	Ω
Dynamic ch	aracteristics	-				
Q <sub>G(tot)</sub>	total gate charge	$I_D = 25 \text{ A}; V_{DS} = 50 \text{ V}; V_{GS} = 10 \text{ V};$ $T_j = 25 \text{ °C}; Fig. 2$	[tbd]	316	[tbd]	nC
		I <sub>D</sub> = 0 A; V <sub>DS</sub> = 0 V; V <sub>GS</sub> = 10 V; T <sub>i</sub> = 25 °C	-	168	-	nC
Q <sub>GS</sub>	gate-source charge	$I_D = 25 \text{ A}; V_{DS} = 50 \text{ V}; V_{GS} = 10 \text{ V};$ $T_j = 25 \text{ °C}; Fig. 2$	[tbd]	102	[tbd]	nC
Q <sub>GS(th)</sub>	pre-threshold gate- source charge	$I_D = 25 \text{ A}; V_{DS} = 50 \text{ V}; V_{GS} = 10 \text{ V};$ $T_i = 25 \text{ °C}$	-	68	-	nC
Q <sub>GS(th-pl)</sub>	post-threshold gate- source charge	,	-	34	-	nC
Q <sub>GD</sub>	gate-drain charge	I <sub>D</sub> = 25 A; V <sub>DS</sub> = 50 V; V <sub>GS</sub> = 10 V; T <sub>j</sub> = 25 °C; <u>Fig. 2</u>	-	49	-	nC
V <sub>GS(pl)</sub>	gate-source plateau voltage	$I_D = 25 \text{ A}; V_{DS} = 50 \text{ V}; T_j = 25 \text{ °C}$	-	[tbd]	-	V
C <sub>iss</sub>	input capacitance	V <sub>DS</sub> = 50 V; V <sub>GS</sub> = 0 V; f = 1 MHz;	[tbd]	24498	[tbd]	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C	[tbd]	5222	[tbd]	pF
C <sub>rss</sub>	reverse transfer capacitance		[tbd]	69	[tbd]	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS} = 50 \text{ V}; R_L = 2 \Omega; V_{GS} = 10 \text{ V};$	-	77	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 5 \Omega; T_j = 25 ^{\circ}C$	-	74	-	ns
$t_{d(off)}$	turn-off delay time		-	187	-	ns
t <sub>f</sub>	fall time		-	104	-	ns
Source-drai	n diode			'	1	
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = 25 A; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	[tbd]	1	V
	reverse recovery time	L = 25 A: dL/dt = 100 A/us: \/ = 0 \/:		87		ns
t <sub>rr</sub>	reverse recovery unite	= 25 A; $d_{S}/dt = -100 \text{ A/}\mu\text{s}$ ; $V_{GS} = 0 \text{ V}$ ; $V_{GS} = 50 \text{ V}$ ; $V_{GS} = 50$	-	07	-	115

<sup>[1]</sup> includes capacitive recovery

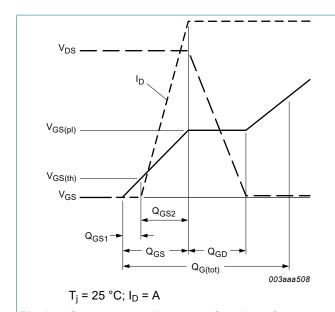


Fig. 2. Gate-source voltage as a function of gate charge; typical values

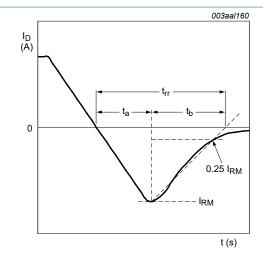


Fig. 3. Reverse recovery timing definition

# 10. Package outline

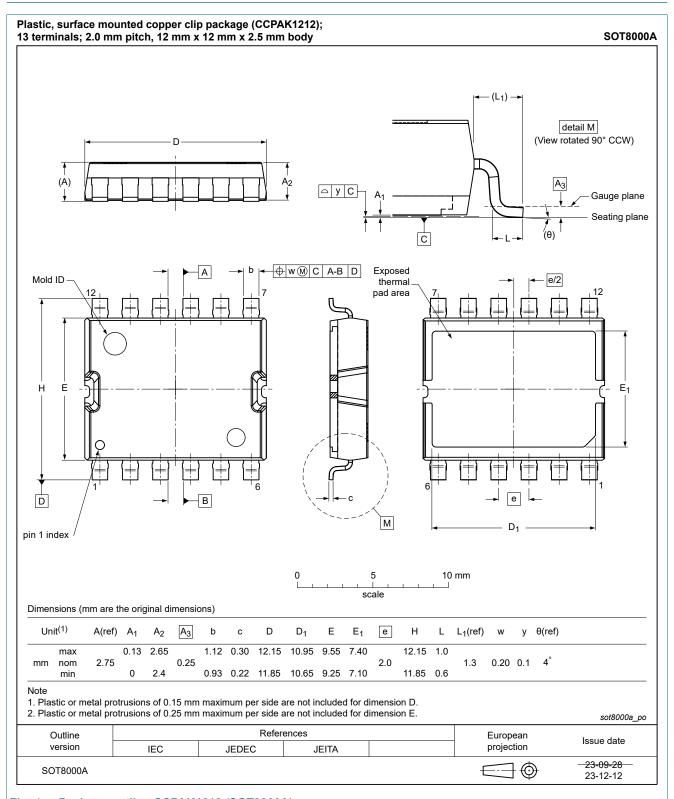


Fig. 4. Package outline CCPAK1212 (SOT8000A)

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